Unit: mm

0.13

# **DB3J316J**

## Silicon epitaxial planar type

For small current rectification DB3X316J in SMini3 type package

#### ■ Features

- Short reverse recovery time t<sub>rr</sub>
- Low forward voltage V<sub>F</sub>
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

#### ■ Marking Symbol: 5G

#### ■ Basic Part Number

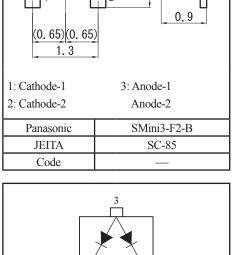
Dual DB2S316 (Common Anode)

#### Packaging

 $DB3J316J0L \quad Embossed \ type \ (Thermo-compression \ sealing): \ 3\,000 \ pcs \ / \ reel \ (standard)$ 

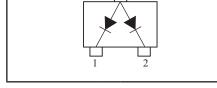
## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit		
Reverse voltage		V <sub>R</sub>	30	V	
Repetitive peak reverse voltage		V <sub>RRM</sub>	30	V	
Forward current (Average)	Single	т.	100	mA	
	Double *1	$I_{F(AV)}$	70		
Peak forward current	Single	_	300	mA	
	Double *1	$I_{FM}$	200		
Non-repetitive peak forward surge current *2		I <sub>FSM</sub>	1	A	
Junction temperature		T <sub>j</sub>	125	°C	
Operating ambient temperature		T <sub>opr</sub>	T <sub>opr</sub> -40 to +85		
Storage temperature		T <sub>stg</sub>	-55 to +125	°C	



2.0

0.3

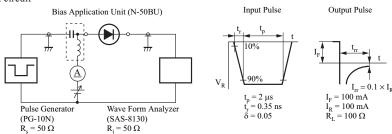


## ■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 100 \text{ mA}$			0.55	V
Reverse current	$I_R$	$V_R = 30 \text{ V}$			15	μΑ
Terminal capacitance	Ct	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$		2		pF
Reverse recovery time *1	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}, I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$		0.8		ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

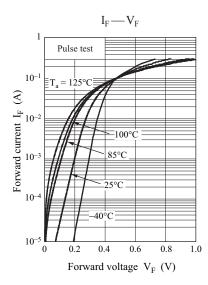
- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. Absolute frequency of input and output is 250 MHz
  - \*1: t<sub>rr</sub> measurement circuit

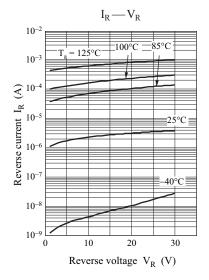


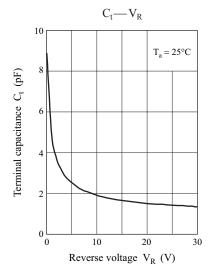
Note) \*1: Value of each diode in double diodes used.

<sup>\*2: 50</sup> Hz sine wave 1 cycle (Non-repetitive peak current)

DB3J316J Panasonic

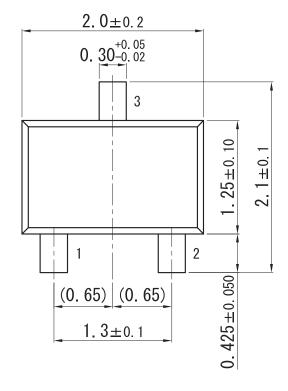


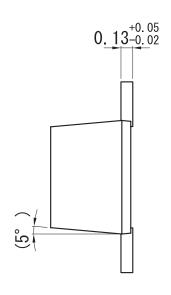


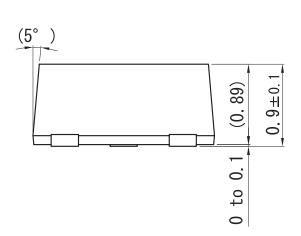


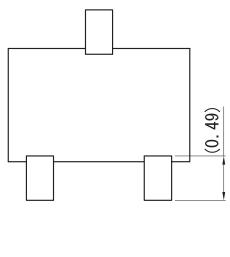
# SMini3-F2-B

Unit: mm

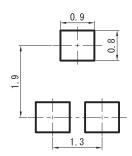








## ■ Land Pattern (Reference) (Unit: mm)



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